#### PRELIMINARY PRODUCT INFORMATION



## GaAs INTEGRATED CIRCUIT UPG2163T5N

#### GaAs MMIC SPDT SWITCH FOR 2.4 GHz AND 5 GHz DUALBAND WIRELESS LAN

#### **DESCRIPTION**

The uPG2163T5N is a GaAs MMIC SPDT switch for 2.4 GHz and 5 GHz dualband wireless LAN. Low insertion loss and dual band operations suit to dualband wireless LAN system.

#### **FEATURES**

Operating frequency : f = 2.4 to 2.5 GHz and 4.9 to 6.0 GHz
 Low insertion loss : Lins = 0.4 dB TYP. @ f = 2.4 to 2.5 GHz

: Lins = 0.4 dB TYP. @ f = 2.4 to 2.5 GHz

• Handling power :  $P_{in (1 dB)} = +31 dBm TYP$ . @ f = 2.5 GHz

+29 dBm TYP. @ f = 6.0 GHz

• High isolation : ISL = 35 dB TYP. @ f = 2.4 to 2.5 GHz

: ISL = 30 dB TYP. @ f = 4.9 to 6.0 GHz

• Input/output return loss : RLin/RLout = 15 dB TYP. @ f = 2.4 to 2.5 GHz

:  $RL_{in}/RL_{out} = 15 dB TYP$ . @ f = 4.9 to 6.0 GHz

6-pin plastic TSON package (1.5 × 1.5 × 0.4 mm)

#### **APPLICATION**

2.4 GHz and 5 GHz dualband wireless LAN: IEEE802.11a+b/g

#### ORDERING INFORMATION

Part Number	Package	Marking	Supplying Form
uPG2163T5N-E2	6pinTSON		Embossed tape 8 mm wide     Pin 1.6 face to tape perforation side     Qty TBD kpcs/reel

Remark To order evaluation samples, contact your nearby sales office.

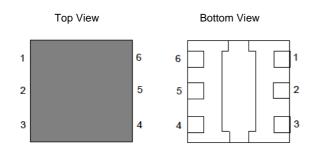
Part number for sample order: uPG2163T5N

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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#### PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	NC (GND)
2	Vcont2
3	RX
4	TX
5	Vcont1
6	ANT
EXPOSED PAD	GND

**Remark** NC is functionally non-connection pin but actually grounding is recommended.

#### **TRUTH TABLE**

Vcont1	V <sub>cont2</sub>	ANT-RX	ANT-TX
High	Low	ON	OFF
Low	High	OFF	ON

#### ABSOLUTE MAXIMUM RATINGS (TA = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	V <sub>cont</sub>	-6.0 to +6.0 Note 1	V
Input Power	Pin	TBD	dBm
Operating Ambient Temperature	TA	-45 to +85	°C
Storage Temperature	Tstg	–55 to +150	°C

Notes 1.  $|V_{cont1} - V_{cont2}| \le 6.0 \text{ V}$ 



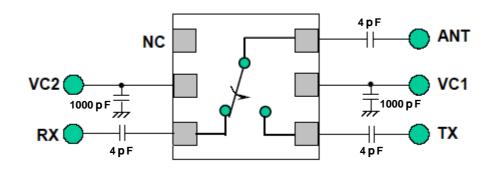
#### RECOMMENDED OPERATING RANGE ( $T_A = +25$ °C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency 1	f1	2.4	-	2.5	GHz
Operating Frequency 2	f2	4.9	-	6.0	GHz
Switch Control Voltage (H)	V <sub>cont (H)</sub>	2.7	3.0	5.0	V
Switch Control Voltage (L)	Vcont (L)	-0.2	0	0.2	V

### ELECTRICAL CHARACTERISTICS (TA = +25°C, $V_{cont}$ = 3.0 V/0 V, $Z_{O}$ = 50 $\Omega$ , DC blocking capacitors value: 4 pF, Each port, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss	Lins	f = 2.4 to 2.5 GHz	-	0.4	TBD	dB
		f = 4.9 to 6.0 GHz	ı	0.5	TBD	dB
Isolation	ISL	f = 2.4 to 2.5 GHz	TBD	35	-	dB
		f = 4.9 to 6.0 GHz	TBD	30	-	dB
Input Return Loss	RLin	f = 2.4 to 2.5 GHz	I	15	-	dB
		f = 4.9 to 6.0 GHz	I	15	-	dB
Output Return Loss	RLout	f = 2.4 to 2.5 GHz		15	-	dB
		f = 4.9 to 6.0 GHz	1	15	-	dB
1 dB Gain Compression	Pin (1 dB)	f = 2.5 GHz	I	31	-	dBm
Input Power		f = 6.0 GHz	I	29	-	dBm
Switch Control Speed	tsw		Í	50	-	ns
Control Current	Icont	RF Non	=	0.7	1.5	μА

#### **EVALUATION CIRCUIT**

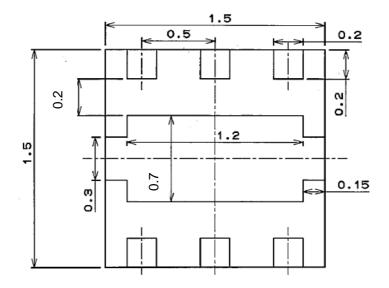


The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

#### **PACKAGE DIMENSIONS**

6-PIN PLASTIC TSON (UNIT: mm)

(Bottom View)



# Preliminary

(Side View)



u**PG2163T5N** 

- The information in this document is current as of March, 2004. The information is subject to change
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NEC uPG2163T5N

#### Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

#### ▶ For further information, please contact

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